COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

TEL: 886-2-2369 2800 FAX: 886-2-2369 7233

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

FLIP-CHIP DIE AND FLIP-CHIP PACKAGE SUBSTRATE

| the | specification of which | ch | | | | |
|--------------------|---|---|--|--|--|--|
| _X | is attached hereto was filed on | | | | | |
| | as Application Ser | ial No | and was amended on_ | | · | |
| app app forc | ecification, including to I acknowledge the olication in accordand I hereby claim fore olication(s) for pater | the claims, as amended to duty to disclose informable with Title 37, Code or eign priority benefits und at or inventor's certificatent or inventor's certificatent. | nd understand the content by any amendment referred mation which is material to f Federal Regulations, § 1. Her Title 35, United States Co to listed below and have ficate having a filing date be | ed to above. the paten 56(a). Code, § 119 also identif | tability of this 9 of any foreign fied below any | |
| | Number | Country | Date Filed(yyyy/mm/dd) | Yes | No | |
| | 91205886 | Taiwan, R.O.C. | 2002/4/29 | X | | |
| traı | | |)) | vith: | olication and to | |
| | SEND CORRESPONDENCE TO: | | | DIRECT TELEPHONE CALLS TO: (Name and telephone number) | | |
| | | cellectual Property Off osevelt Rd., Sec. 2, ı, R.O.C. | | Belinda Lee | | |

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature

May 13, 2002

Sole or First Joint Inventor: Chi-Hsing Hsu

Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: 9F-1, No. 23, Changlung St., Hsinchuang, Taipei Hsien, Taiwan, R.O.C.